

Temperature Compensated Crystal Oscillator (温补振荡器) - K(V)T50

Feature 特征

- Frequency Stability reaches 0.5ppm -20~70°C 频率稳定度可达到 0.5ppm

Applications 应用

- Time benchmarking, mobile devices, wireless communications, precision meters, intelligent monitoring, etc. 时间基准, 移动设备, 无线通讯, 精密仪表, 智能监控等



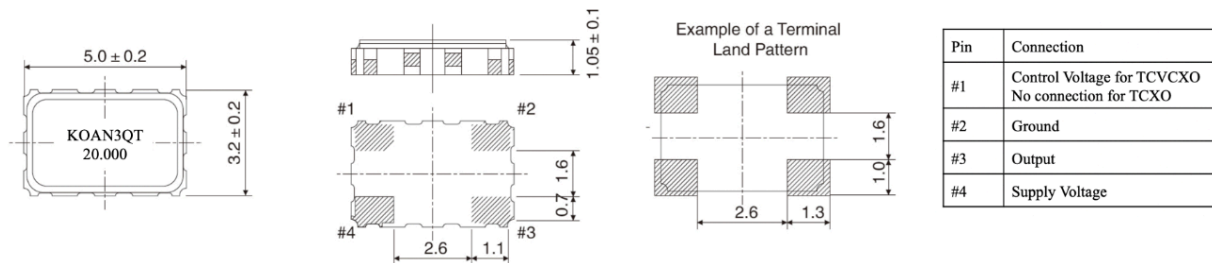
General Specifications 规格参考

PARAMETER	性能参数	TCXO: KT50, VCTCXO: KVT50		
Frequency Range	频率范围	6.4~40.0MHz		
Supply Voltage	工作电压	+2.5V(±10%)	+3.0V(±10%)	+3.3V(±10%)
Output Level High '1'	输出电平 高	0.9V _{dd} min.		
Output Level Low '0'	输出电平 低	0.1V _{dd} max.		
Output Logic	输出波形	CMOS		
Output Load	输出负载	15pF		
Initial Calibration Tolerance	调整频差	<±2ppm at +25°C		
Current Consumption	工作电流	6mA max		
Frequency Stability 频率温度稳定度 VS				
Aging	老化率	±1.0ppm/year max		
Voltage Change	电压变化	±0.3ppm max for ±5% input voltage change		
Load Change	负载变化	±0.3ppm max for ±10% load condition change		
Reflow (SMD type)	回流焊 (SMD)	±1.0ppm max. 1 reflow and measured 24hs afterwards		
Control Voltage Center	中心控制电压	1.4V±1.0V	1.5V±1.0V	1.5V±1.0V
Frequency Deviation Range	电压调整	±5ppm min.		
Input Impedance	输入电阻	500MΩ min.		
Modulation Bandwidth	调制宽带	20KHz min.		
Phase noise	相位噪声	-96@10Hz (13MHz)		
Linearity	非线性误差	±10% max.		
Start-up Time	起振时间	5.0ms typ. 10.0ms max.		
Storage Temperature Range	储存温度范围	-55°C~+125°C		

Frequency Stability 温度频差 VS Operating Temperature Range 温度范围						
Temp. Code	Temp. \ppm	±0.5	±1.0	±2.0	±3.0	±5.0
B	-20~70°C	○	○	○	○	○
C	-40~85°C		○	○	○	○
D	-20~105°C			○	○	○
E	-40~105°C				○	○
F	-55~105°C					○
G	-20~125°C					○

NOTE: Please consult for other specifications 若有其它规格需求请告知

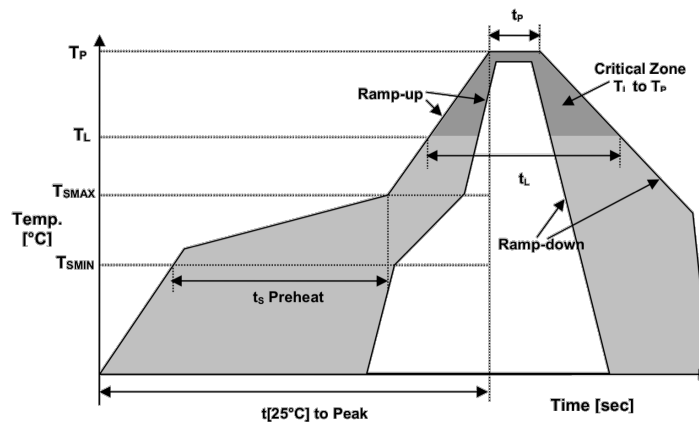
Outline Dimensions (Unit: mm) 外形尺寸



Part Number Guide 产品编号

<u>KT50</u>	-	<u>20.000</u>	-	<u>33</u>	-	<u>C</u>	-	<u>03</u>	-	<u>NS</u>
↓		↓		↓		↓		↓		↓
型号	-	标称频率	-	工作电压	-	工作温度	-	温度频差	-	特殊要求
'KT':产品系列 KT: TCXO KVT: VCTCXO '50':封装尺寸 SMD 5.0x3.2mm		(In MHz)		25=2.5V 30=3.0V 33=3.3V		B: -20~+70°C C: -40~+85°C D: -20~+105°C E: -40~+105°C F: -55~+105°C G: -20~+125°C		A5 = ±0.5ppm 01 = ±1.0ppm 02 = ±2.0ppm 03 = ±3.0ppm 05 = ±5.0ppm		'NS':特殊要求

Reflow Profile 回流焊



Temperature Min Preheat	最低预热温度	T_{smin}	150°C
Temperature Max preheat	最高预热温度	T_{smax}	200°C
Time (T_{smin} to T_{smax})	时间差	T_s	60~120 sec
Temperature	温度	T_L	217°C
Peak Temperature	最高温	T_p	260 °C
Ramp-up Rate	升温速度	R_{up}	3°C/sec max
Ramp-down Rate	降温速度	R_{down}	6°C/sec max
Time within 5°C of Peak Temperature	最高温度停留时间	t_p	30 sec
Time $t[25°C]$ to peak temperature	25度到最高温度时间	$t[25°C]$ to peak	480 sec
Time	时间	t_L	60~150 sec